

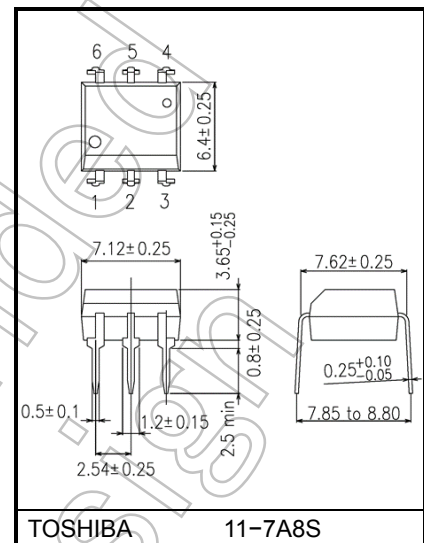
TLP330

Programmable Controllers
AC / DC-Input Module
Telecommunication

Unit: mm

The TOSHIBA TLP330 consists of a photo-transistor optically coupled to infrared emitting diode connected inverse parallel in a six lead plastic DIP package. This is suitable for application of AC input current up to 150mA.

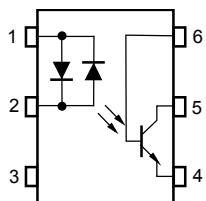
- If maximum rating: $\pm 150\text{mA}$
- Collector-Emitter voltage: $55\text{V}(\text{min.})$
- Current transfer ratio: $25\%(\text{min.})(I_F = \pm 20\text{mA})$
- Isolation voltage: $5000\text{Vrms}(\text{min.})$
- UL-recognized: UL 1577, File No.E67349
- cUL-recognized: CSA Component Acceptance Service No.5A
File No.E67349



TOSHIBA 11-7A8S

Weight: 0.39 g (typ.)

Pin Configurations (top view)



- 1: Anode, cathode
- 2: Cathode, anode
- 3: NC
- 4: Emitter
- 5: Collector
- 6: Base

Start of commercial production
1986-03

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
LED	Forward current	I_F	± 150	mA
	Forward current derating (Ta $\geq 25^\circ\text{C}$)	$\Delta I_F / ^\circ\text{C}$	-1.5	mA / $^\circ\text{C}$
	Peak forward current (100 μs pulse, 100pps)	I_{FP}	± 1	A
	Diode power dissipation	P_D	200	mW
	Diode power dissipation derating (Ta $\geq 25^\circ\text{C}$)	$\Delta P_D / ^\circ\text{C}$	-2.0	mW / $^\circ\text{C}$
	Junction temperature	T_j	125	$^\circ\text{C}$
Detector	Collector-emitter voltage	V_{CEO}	55	V
	Collector-base voltage	V_{CBO}	80	V
	Emitter-collector voltage	V_{ECO}	7	V
	Emitter-base voltage	V_{EBO}	7	V
	Collector current	I_C	80	mA
	Power dissipation	P_C	150	mW
	Power dissipation derating (Ta $\geq 25^\circ\text{C}$)	$\Delta P_C / ^\circ\text{C}$	-1.5	mW / $^\circ\text{C}$
	Junction temperature	T_j	125	$^\circ\text{C}$
Storage temperature range		T_{stg}	-55 to 125	$^\circ\text{C}$
Operating temperature range		T_{opr}	-55 to 100	$^\circ\text{C}$
Lead soldering temperature (10 s)		T_{sol}	260	$^\circ\text{C}$
Total package power dissipation		P_T	250	mW
Total package power dissipation derating (Ta $\geq 25^\circ\text{C}$)		$\Delta P_T / ^\circ\text{C}$	-2.5	mW / $^\circ\text{C}$
Isolation voltage (AC, 60 s, R.H. $\leq 60\%$) (Note 1)		BV_S	5000	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1 Device considered a two terminal device: Pins 1, 2 and 3 shorted together and pins 4, 5 and 6 shorted together.

Recommended Operating Conditions

Characteristics	Symbol	Min.	Typ.	Max.	Unit
Supply voltage	V_{CC}	—	5	24	V
Forward current	$I_{F(RMS)}$	—	20	120	mA
Collector current	I_C	—	1	10	mA
Operating temperature	T_{opr}	-25	—	85	$^\circ\text{C}$

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Individual Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Condition	Min.	Typ.	Max.	Unit
LED	Forward voltage	V _F	I _F = ±100 mA	—	1.4	1.7	V
	Forward current	I _F	V _F = ±0.7V	—	2.5	20	μA
	Capacitance	C _T	V = 0 V, f = 1 MHz	—	100	—	pF
Detector	Collector-emitter breakdown voltage	V _{(BR) CEO}	I _C = 0.5 mA	55	—	—	V
	Emitter-collector breakdown voltage	V _{(BR) ECO}	I _E = 0.1 mA	7	—	—	V
	Collector-base breakdown voltage	V _{(BR) CBO}	I _C = 0.1 mA	80	—	—	V
	Emitter-base breakdown voltage	V _{(BR) EBO}	I _E = 0.1 mA	7	—	—	V
	Collector dark current	I _{CEO}	V _{CE} = 24 V	—	10	100	nA
			V _{CE} = 24 V, T _a = 85 °C	—	2	50	μA
	Collector dark current	I _{CER}	V _{CE} = 24 V, T _a = 85 °C R _{BE} = 1MΩ	—	0.5	10	μA
	Collector dark current	I _{CBO}	V _{CE} = 10V	—	0.1	—	nA
	DC forward current gain	h _{FE}	V _{CE} = 5 V, I _C = 0.5mA	—	400	—	—
Capacitance (collector to emitter)	C _{CE}	V = 0 V, f = 1.MHz	—	10	—	pF	

Coupled Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Condition	Min.	Typ.	Max.	Unit
Current transfer ratio	I _C / I _F	I _F = ±20 mA V _{CE} = 1 V	25	—	—	%
	I _C / I _F (high)	I _F = ±100 mA V _{CE} = 1 V	20	—	80	%
Base photo-current	I _{PB}	I _F = ±5 mA, V _{CB} = 5 V	—	10	—	μA
Collector-emitter saturation voltage	V _{CE} (sat)	I _C = 2.4 mA, I _F = 20 mA	—	—	0.4	V
		I _C = 2.4 mA, I _F = ±100 mA	—	—	0.4	
Off-state collector current	I _{C(off)}	V _F = ± 0.7 V, V _{CE} = 24 V	—	1	10	μA
CTR symmetry	I _C (ratio)	I _C (I _F = -20 mA) / I _C (I _F = +20 mA)	0.5	1	2	—

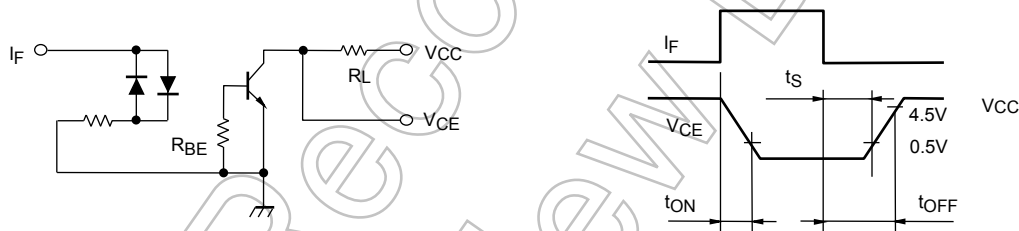
Isolation Characteristics (Ta = 25°C)

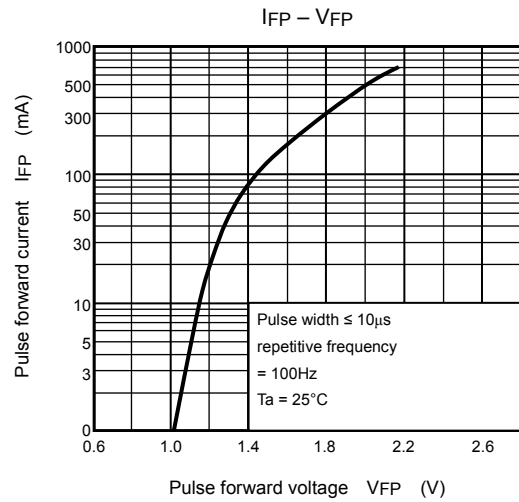
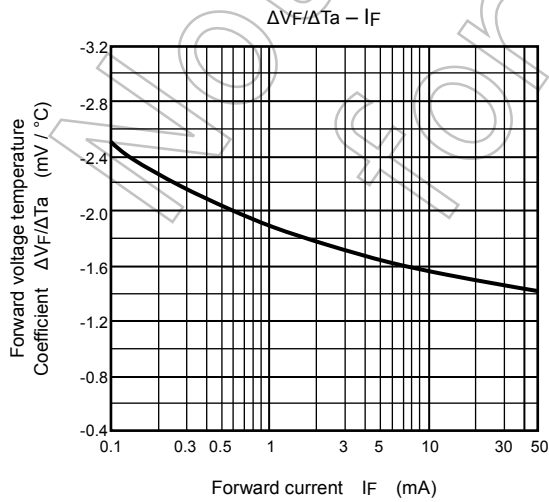
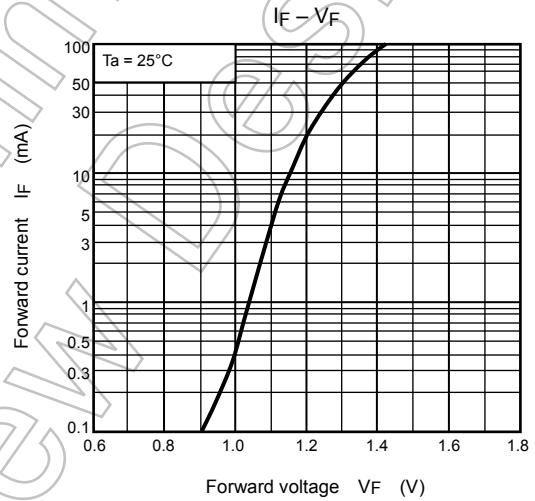
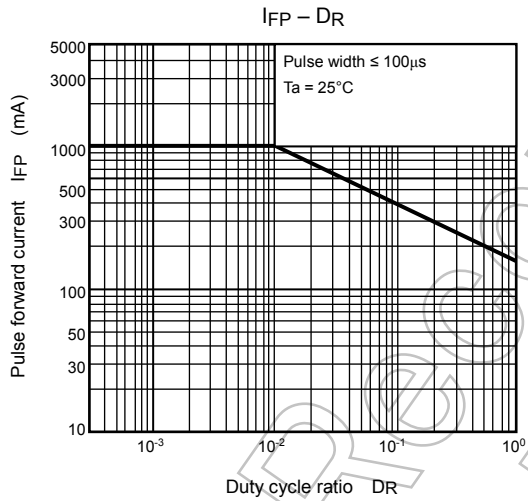
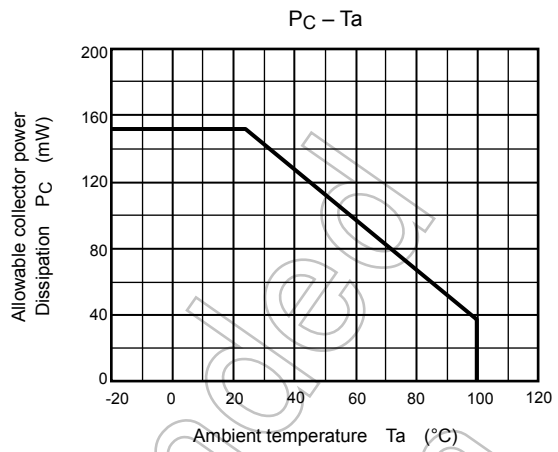
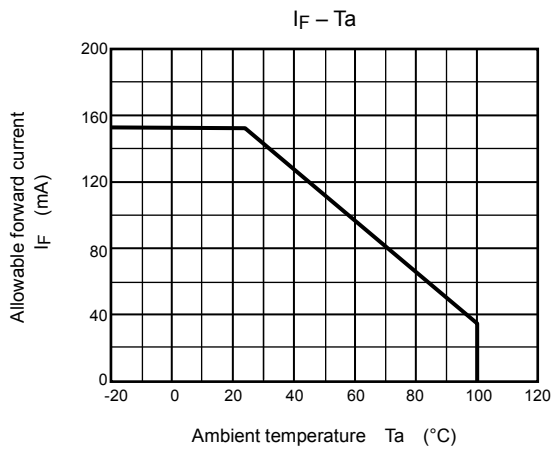
Characteristics	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Capacitance (input to output)	Cs	V _S = 0 V, f = 1 MHz	—	0.8	—	pF
Isolation resistance	R _S	V _S = 500 V, R.H. ≤ 60 %	5×10 ¹⁰	10 ¹⁴	—	Ω
Isolation voltage	BV _S	AC, 60 s	5000	—	—	V _{rms}

Switching Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Rise time	t _r	V _{CC} = 10 V I _C = 2 mA R _L = 100 Ω	—	2	—	μs
Fall time	t _f		—	3	—	
Turn-on time	t _{on}		—	3	—	
Turn-off time	t _{off}		—	3	—	
Turn-on time	t _{ON}	R _L = 1.9 kΩ (Fig.1) R _{BE} = OPEN V _{CC} = 5 V, I _F = ±16 mA	—	2	—	μs
Storage time	t _s		—	15	—	
Turn-off time	t _{OFF}		—	25	—	
Turn-on time	t _{ON}	R _L = 1.9 kΩ (Fig.1) R _{BE} = 220 kΩ V _{CC} = 5 V, I _F = ±16 mA	—	2	—	μs
Storage time	t _s		—	12	—	
Turn-off time	t _{OFF}		—	20	—	

Fig. 1 Switching time test circuit





NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

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